

PCB

Board size: 65.75x37.75 mm (2.59x1.49 inches)

- This is the size of the rectangle that contains the board
- Thickness: 1.6 mm (63 mils)
- Material: FR4
- Finish: None
- Layers: 2
- Copper thickness: 35 μ m

Solder mask: TOP / BOTTOM

- Color: Green

Silk screen: TOP / BOTTOM

- Color: White

Stackup:

Name	Type	Color	Thickness	Material	Epsilon_r	Loss tangent
F.SilkS	Top Silk Screen					
F.Paste	Top Solder Paste					
F.Mask	Top Solder Mask		10			
F.Cu	copper		35			
dielectric 1	core		1510	FR4	4.5	0.020
B.Cu	copper		35			
B.Mask	Bottom Solder Mask		10			
B.Paste	Bottom Solder Paste					
B.SilkS	Bottom Silk Screen					

Important sizes

Clearance: 0.2 mm (8 mils)

Track width: 0.25 mm (10 mils)

- By design rules: 0.0 mm (0 mils)

Drill: 0.5 mm (20 mils)

- Vias: 0.5 mm (20 mils) [Design: 0.4 mm (16 mils)]
- Pads: 1.1 mm (43 mils)
- The above values are real drill sizes, they add 0.1 mm (4 mils) to plated holes (PTH)

Via: 0.8/0.4 mm (31/16 mils)

- By design rules: 0.5/0.3 mm (20/12 mils)

- Micro via: yes [0.2/0.1 mm (8/4 mils)]
- Buried/blind via: yes
- Total: 5 (thru: 5 buried/blind: 0 micro: 0)

Outer Annular Ring: 0.15 mm (6 mils)

- By design rules: 0.3 mm (12 mils)

Eurocircuits class: 4B - Using min drill 0.5 mm for an OAR of 0.15 mm

General stats

Components count: (SMD/THT)

- Top: 16/4 (SMD + THT)
- Bottom: 0/0 (NONE)

Defined tracks:

Used tracks:

- 0.25 mm (10 mils) (36) defined: no
- 0.5 mm (20 mils) (15) defined: no
- 1.5 mm (59 mils) (45) defined: no

Defined vias:

Used vias:

- 0.8/0.4 mm (31/16 mils) (Count: 3, Aspect: 2.0 A) defined: no
- 1.4/0.8 mm (55/31 mils) (Count: 2, Aspect: 1.1 A) defined: no

Holes (excluding vias):

- 1.0 mm (39 mils) (4)
- 1.2 mm (47 mils) (4)

Oval holes:

Drill tools (including vias and computing adjusts and rounding):

- 0.5 mm (20 mils) (3)
- 0.9 mm (35 mils) (2)
- 1.1 mm (43 mils) (4)
- 1.3 mm (51 mils) (4)